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POUGHKEEPSIE, NY 12603

RECEIPT
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December 28, 2000

To: Assistant Commissioner of Patents
Office of Initial Patent Examination
Customer Service Center
Washington, D.C. 20231

From: Stephen B. Ackerman

Subject: Serial No.: 09/684,519
Filing Date: 10/10/2000
Inventor: J. Y. Lee
Title: Thermally Compliant PCB Substrate for the Application of Chip Scale Packages

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REQUEST TO CORRECT FILING RECEIPT

Dear Sir:

On the copy of the enclosed Filing Receipt, there are errors in the list of Applicants and the Title. The first Applicant's name is misspelled. Mr. Lee's corrected name and residence reads; **Jin-Yuan Lee, Hsin-Chu, Taiwan**. Acronyms in the Title should be capitalized. The corrected Title reads: **Thermally compliant PCB substrate for the application of chip scale packages**.

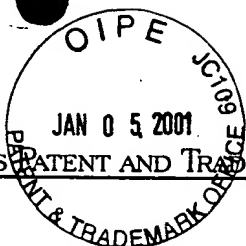
Please make the necessary changes to correct the errors on the Filing Receipt.

If there are any questions, please contact the undersigned attorney at (845) 452-5863. Thank you for your attention to this matter.

Respectfully Submitted,

Stephen B. Ackerman, Reg. No. 37,761

DEC 14 2000



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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/684,519	10/10/2000	2841	823	MEG2000-001	3	72	2

George O Saile
20 McIntosh Drive
Poughkeepsie, NY 12603

FILING RECEIPT



OC000000005606421

Date Mailed: 12/08/2000

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the PTO processes the reply to the Notice, the PTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Jin
Yin-Yuan Lee, Hsin-Chu, TAIWAN;

Continuing Data as Claimed by Applicant

Foreign Applications

If Required, Foreign Filing License Granted 12/07/2000

** SMALL ENTITY **

Title

Thermally compliant pcb substrate for the application of chip scale packages

Preliminary Class

361

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Data entry by : BALL, ROSALIND

Team : OIPE

Date: 12/08/2000



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Bib Data Sheet

CONFIRMATION NO. 3369

SERIAL NUMBER 09/684,519	FILING DATE 10/10/2000 RULE	CLASS 361	GROUP ART UNIT 2841	ATTORNEY DOCKET NO. MEG2000-001	
APPLICANTS Jin-Yuan Lee, Hsin-Chu, TAIWAN; ** CONTINUING DATA ** <i>HB - None</i> ** FOREIGN APPLICATIONS ** <i>HB - Yes</i>					
IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 12/07/2000					
Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no 35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance Verified and Acknowledged <i>HB</i> Examiner's Signature _____ Initials _____		STATE OR COUNTRY TAIWAN	SHEETS DRAWING 3	TOTAL CLAIMS 72	INDEPENDENT CLAIMS 2
ADDRESS George O Saile 20 McIntosh Drive Poughkeepsie, NY 12603					
TITLE Thermally compliant PCB substrate for the application of chip scale packages					
FILING FEE RECEIVED 823	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit		